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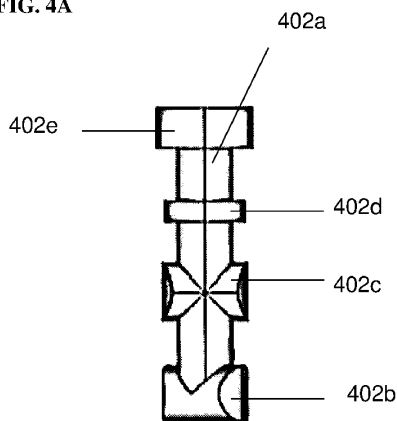
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(54) **Title:** COUPLING ASSEMBLY AND METHOD OF COUPLING

FIG. 4A



Concept Design - Insert

(57) **Abstract:** Various embodiments may relate to a coupling assembly. The coupling assembly may include a first coupling member including a first protruding portion along a first direction and a second protruding portion along a second direction different from the first direction. The coupling assembly may also include a second coupling member including a cover defining a slot opening and a holder coupled to the cover, the holder defining an enclosure. The slot opening may be configured to receive therethrough the first protruding portion when the first protruding portion is aligned with the slot opening. The slot opening may be further configured to receive therethrough the second protruding portion when the second protruding portion is aligned with the slot opening. The enclosure may be configured to receive the first protruding portion and the second protruding portion.

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